

**General Description**

The SJH095N15 uses SGT technology to provide excellent $R_{DS(ON)}$, low gate charge and fast switching characteristics. This device is suitable for use as a wide variety of applications.

Features

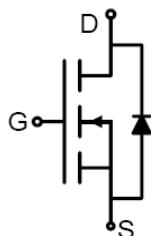
- Low Gate Charge
- 100% UIS Tested, 100% DVDS Tested
- High Power and current handing capability
- Lead free product is acquired

Application

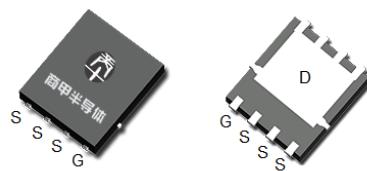
- DC/DC Converter
- Load Switching, Quick/Wireless Charging, Motor Driving

Key Performance Parametes

Parameter	Value	Unit
V_{DS}	150	V
$R_{DS(ON)}_TYP$	9.6	mΩ
I_D	82	A
Q_G	53.5	nC



Schematic Diagram



PDFN5X6-8L top&bottom view

Package Marking and Ordering Information

Device/Ordering Code	Marking	Package	Packing	Reel Size	Tape width	Quantity
SJH095N15	SJH095N15	PDFN5X6-8L	Tape	\	\	5000 Pcs

Table 1. Absolute Maximum Ratings ($T_c=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Limit	Unit
V_{DS}	Drain-Source Voltage ($V_{GS}=0\text{V}$)	150	V
V_{GS}	Gate-Source Voltage ($V_{DS}=0\text{V}$)	± 20	V
I_D	Drain Current-Continuous($T_c=25^\circ\text{C}$)	82	A
	Drain Current-Continuous($T_c=100^\circ\text{C}$)	52	A
I_{DM} (pulse)	Drain Current-Continuous@ Current-Pulsed (Note 1)	328	A
P_D	Maximum Power Dissipation($T_c=25^\circ\text{C}$)	192	W
	Maximum Power Dissipation($T_c=100^\circ\text{C}$)	77	W
E_{AS}	Avalanche energy (Note 2)	650	mJ
T_J, T_{STG}	Operating Junction and Storage Temperature Range	-55 To 150	°C

Table 2. Thermal Characteristic

Symbol	Parameter	Typ	Max	Unit
$R_{θJC}$	Thermal Resistance, Junction-to-Case		0.65	°C/W



150V N-Channel SGT Power MOSFET

Table 3. Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
On/Off States						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$ $I_{\text{D}}=250\mu\text{A}$	150			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}}=150\text{V}$, $V_{\text{GS}}=0\text{V}$ $T_J=25^\circ\text{C}$			1	μA
		$V_{\text{DS}}=150\text{V}$, $V_{\text{GS}}=0\text{V}$ $T_J=125^\circ\text{C}$			100	μA
I_{GSS}	Gate-Body Leakage Current	$V_{\text{GS}}=\pm 20\text{V}$, $V_{\text{DS}}=0\text{V}$			± 100	nA
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$, $I_{\text{D}}=250\mu\text{A}$	1.0		2.5	V
g_{FS}	Forward Transconductance	$V_{\text{DS}}=10\text{V}$, $I_{\text{D}}=20\text{A}$		39		S
$R_{\text{DS(ON)}}$	Drain-Source On-State Resistance	$V_{\text{GS}}=10\text{V}$, $I_{\text{D}}=30\text{A}$ $T_J=25^\circ\text{C}$		9.6	12.5	$\text{m}\Omega$
Dynamic Characteristics						
C_{iss}	Input Capacitance	$V_{\text{DS}}=75\text{V}$, $V_{\text{GS}}=0\text{V}$, $f=1.0\text{MHz}$		4010		pF
C_{oss}	Output Capacitance			316		pF
C_{rss}	Reverse Transfer Capacitance			14		pF
R_g	Gate resistance	$V_{\text{GS}}=0\text{V}$, $V_{\text{DS}}=0\text{V}$, $f=1.0\text{MHz}$		2.3		Ω
Switching Parameters						
$t_{\text{d(on)}}$	Turn-on Delay Time	$V_{\text{GS}}=10\text{V}$, $V_{\text{DS}}=75\text{V}$, $R_L=2.5\Omega$, $R_{\text{GEN}}=3\Omega$		19		nS
t_r	Turn-on Rise Time			45		nS
$t_{\text{d(off)}}$	Turn-Off Delay Time			50		nS
t_f	Turn-Off Fall Time			30		nS
Q_g	Total Gate Charge	$V_{\text{GS}}=10\text{V}$, $V_{\text{DS}}=75\text{V}$, $I_{\text{D}}=30\text{A}$		53.5		nC
Q_{gs}	Gate-Source Charge			16.2		nC
Q_{gd}	Gate-Drain Charge			13.4		nC
Source-Drain Diode Characteristics						
I_{SD}	Source-Drain Current (Body Diode)				82	A
V_{SD}	Forward on Voltage (Note 3)	$V_{\text{GS}}=0\text{V}$, $I_{\text{S}}=20\text{A}$			1.2	V
t_{rr}	Reverse Recovery Time	$I_{\text{F}}=20\text{A}$, $dI/dt=100\text{A}/\mu\text{s}$		86		ns
Q_{rr}	Reverse Recovery Charge	$I_{\text{F}}=20\text{A}$, $dI/dt=100\text{A}/\mu\text{s}$		150		nC

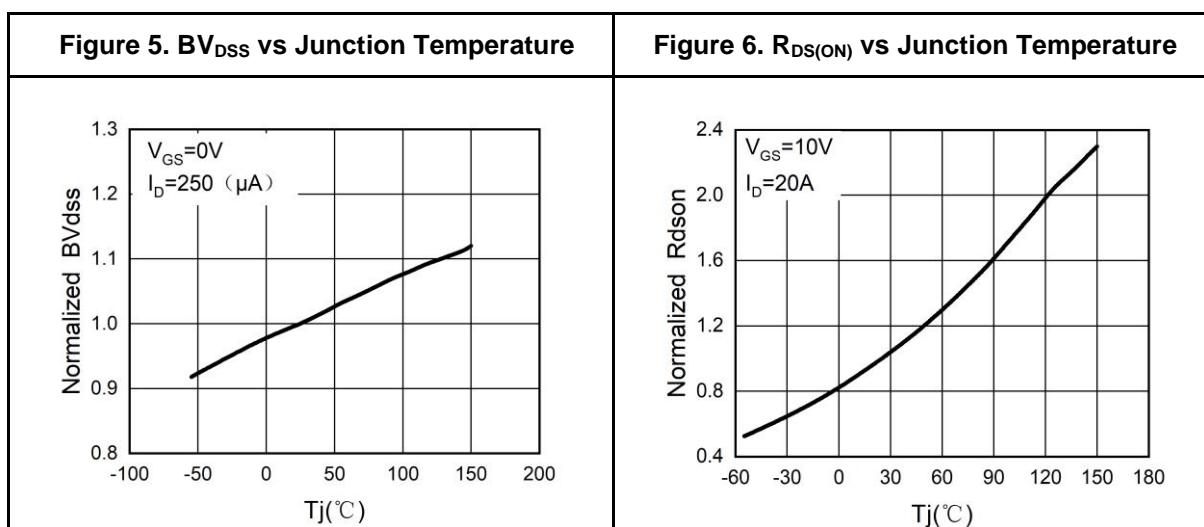
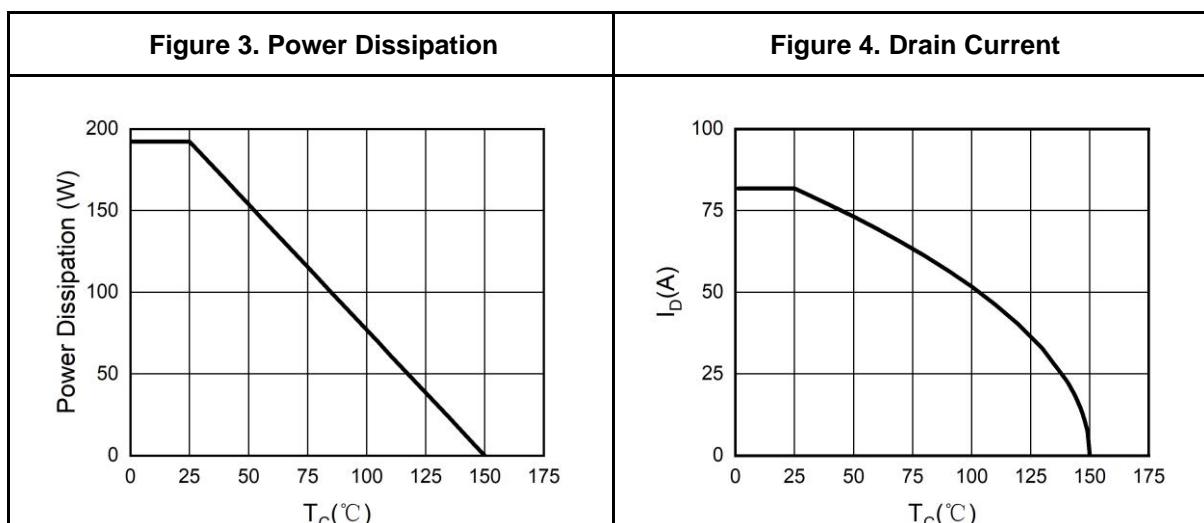
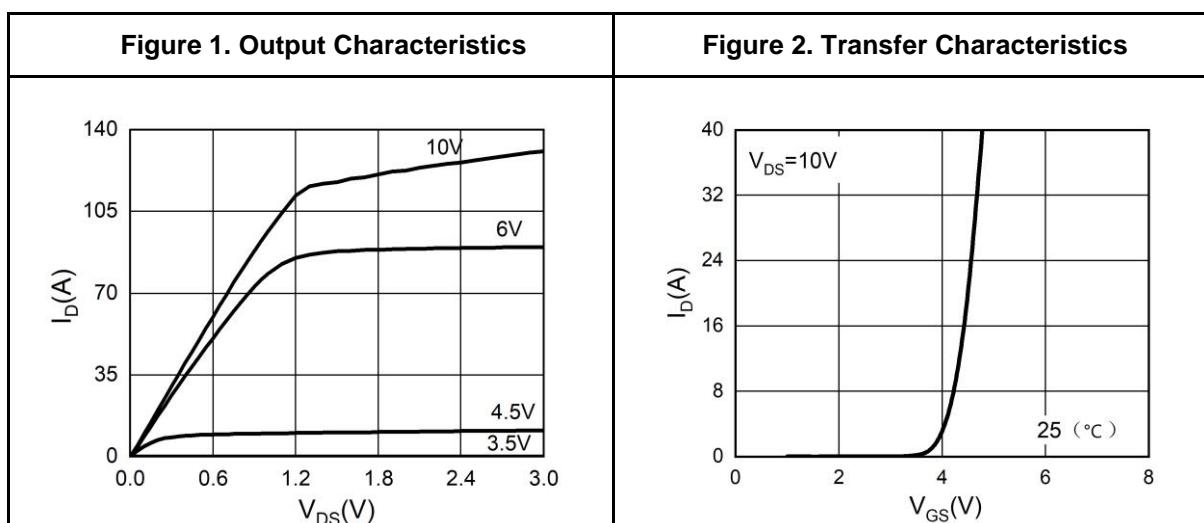
Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

Notes 2.E_{AS} condition: $T_J=25^\circ\text{C}$, $V_{\text{DD}}=100\text{V}$, $V_{\text{G}}=10\text{V}$, $R_g=25\Omega$, $L=0.5\text{mH}$.

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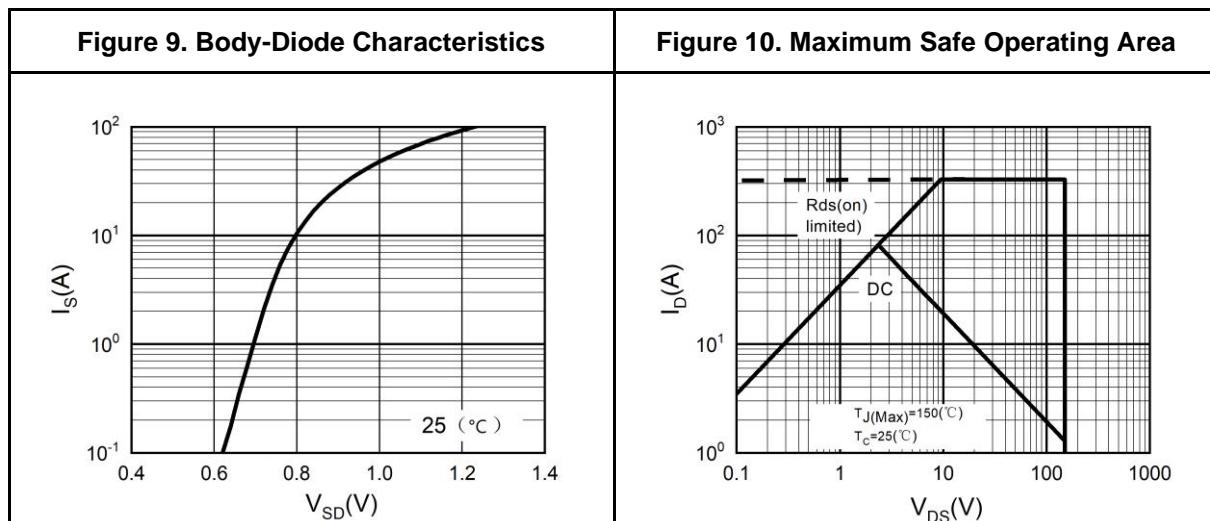
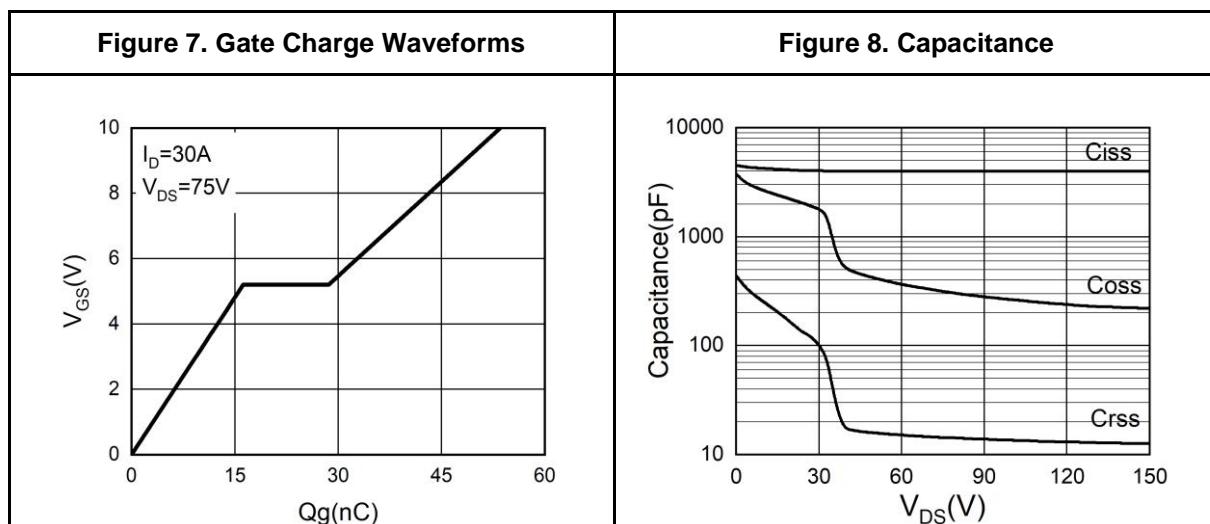


Typical Electrical And Thermal Characteristics (Curves)



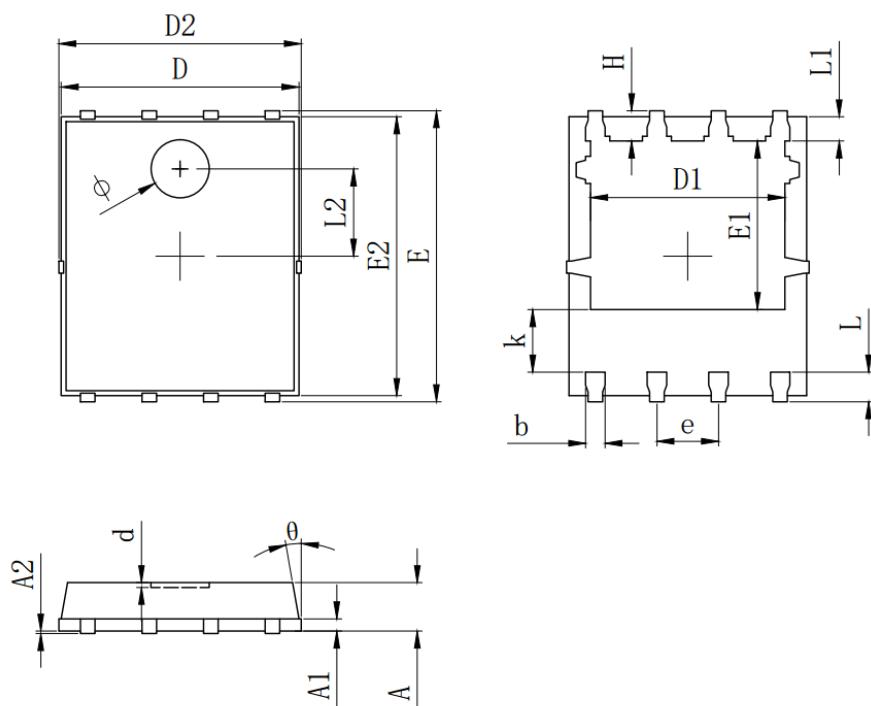


Typical Electrical And Thermal Characteristics (Curves)





PDFN5X6-8L Package Information



SYMBOL	MILLIMETER		
	MIN	Typ.	MAX
A	0.900	1.000	1.100
A1		0.254 REF.	
A2		0~0.05	
D	4.824	4.900	4.976
D1	3.910	4.010	4.110
D2	4.924	5.000	5.076
E	5.924	6.000	6.076
E1	3.375	3.475	3.575
E2	5.674	5.750	5.826
b	0.350	0.400	0.450
e		1.270 TYP.	
L	0.534	0.610	0.686
L1	0.424	0.500	0.576
L2		1.800 REF.	
k	1.190	1.290	1.390
H	0.549	0.625	0.701
θ	8°	10°	12°
Φ	1.100	1.200	1.300
d			0.100

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Attention

This product described in this document can not be used in life support devices or systems, aircraft's control systems, and other applications whose failure can be reasonably expected to result in serious physical and/or material damage, apart from that when an application agreement is signed between customer and Wuxi Shangjia Semiconductor.

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